

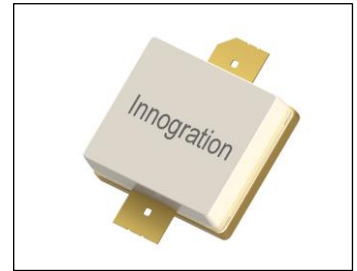


## 80W,28V Sub-1GHz RF LDMOS Transistor

### Description

The ITEH09080A2C is a 80-watt, high performance, LDMOS transistor, designed for any general applications at frequencies up to 1GHz.

**It can be tuned to meet up to 39dBm WCDMA or LTE ACLR without DPD needed purely by back off operation.**



- Typical 758-803MHz Class AB RF Performance (On Innogrations fixture with device soldered).

**V<sub>ds</sub>=28V,I<sub>dq</sub>=590mA**

Freq (MHz)	P <sub>out</sub> (dBm)	CCDF (dB)	P <sub>peak</sub> (dBm)	P <sub>peak</sub> (W)	ACPR (dBc)	Gain (dB)	Efficiency (%)
758	39.02	9.70	48.72	74.5	-47.8	20.3	20.2
781	39.01	9.66	48.67	73.7	-47.9	20.5	21.5
803	39.02	9.49	48.50	70.8	-47.8	21.3	22.8

### Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

### Suitable Applications

- P band power amplifier
- All 4G/5G cellular application within 0.7 to 1GHz

**Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
Drain--Source Voltage	V <sub>DSS</sub>	+65	Vdc
Gate--Source Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	V <sub>DD</sub>	+28	Vdc
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	T <sub>j</sub>	+225	°C

**Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case T <sub>c</sub> = 85°C, DC test, <b>device soldered on heatsink directly</b>	R <sub>θJC</sub>	0.9	°C/W

**Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

**Table 4. Electrical Characteristics** (TA = 25 °C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
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### DC Characteristics



Drain-Source Voltage $V_{GS}=0, I_{DS}=100\mu A$	$V_{(BR)DSS}$		65		V
Zero Gate Voltage Drain Leakage Current $(V_{DS} = 28V, V_{GS} = 0V)$	$I_{DSS}$	—	—	1	$\mu A$
Gate--Source Leakage Current $(V_{GS} = 11V, V_{DS} = 0V)$	$I_{GSS}$	—	—	1	$\mu A$
Gate Threshold Voltage $(V_{DS} = 28V, I_D = 600\mu A)$	$V_{GS(th)}$	—	2	—	V
Gate Quiescent Voltage $(V_{DD} = 28V, I_D = 600mA, \text{Measured in Functional Test})$	$V_{GS(O)}$	—	2.6	—	V

**Load Mismatch (In Innogrations Test Fixture, 50 ohm system):**  $V_{DD} = 28Vdc, I_{DQ} = 600mA, f = 800MHz$

VSWR 10:1 at 80W pulse CW Output Power	No Device Degradation
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### 758-803MHz application board

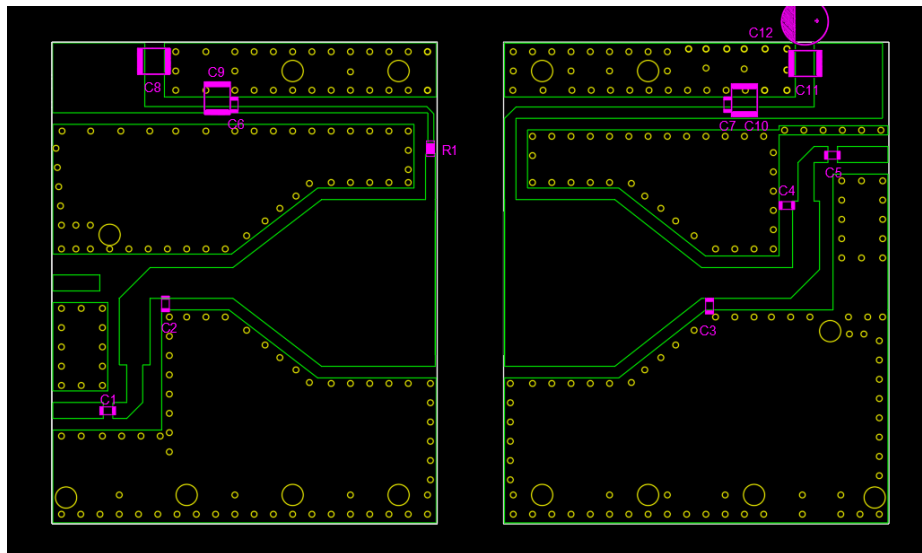


Figure 2. Test Circuit Component Layout, 20mils RO4350B

Note:

Table 5. Test Circuit Component Designations and Values

Reference	Footprint	Value	Quantity
C5, C6, C7	0603	100pF	3
C1	0603	10pF	1
C2	0603	5.6pF	1
C3	0603	8.2pF	1
C4	0603	3.3pF	1
R1	0603	10R	1
C8, C9, C10, C11	1210	10uF/63V	4
C12		470uF/63V	1
U1	C6	ITEH09080A2C	1

## TYPICAL CHARACTERISTICS

Figure 3. Power Gain and Drain Efficiency as function of Power Output

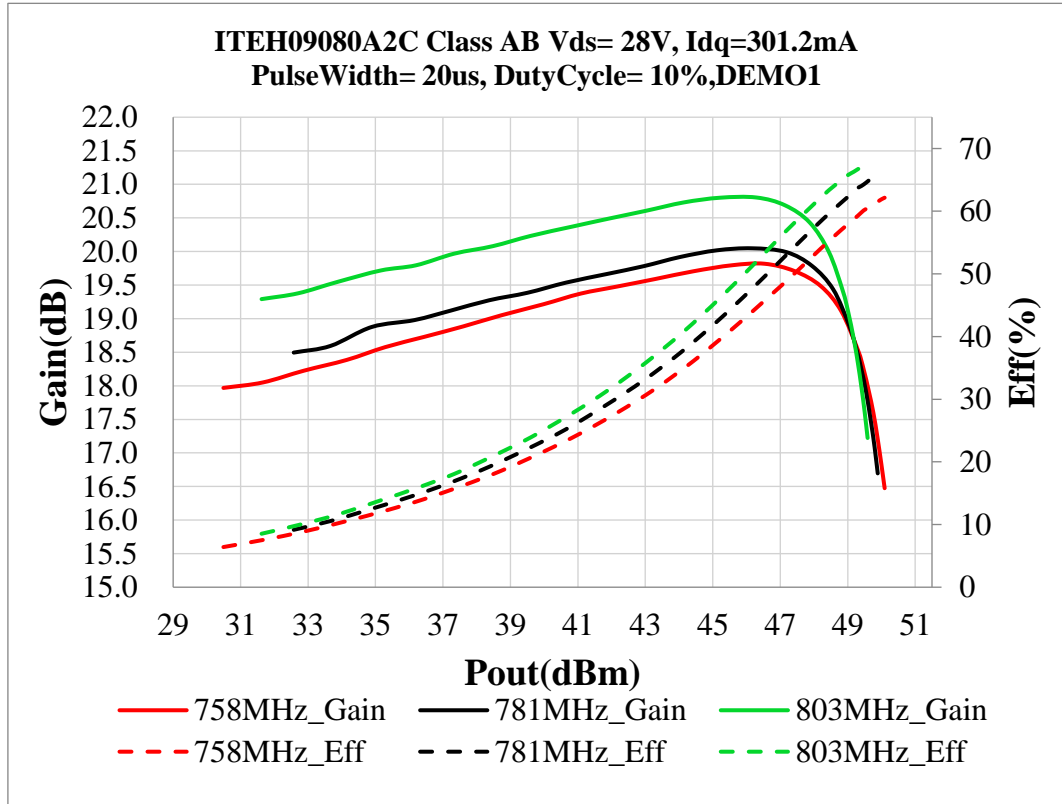
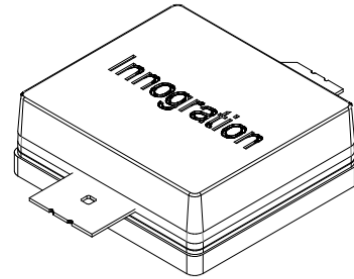
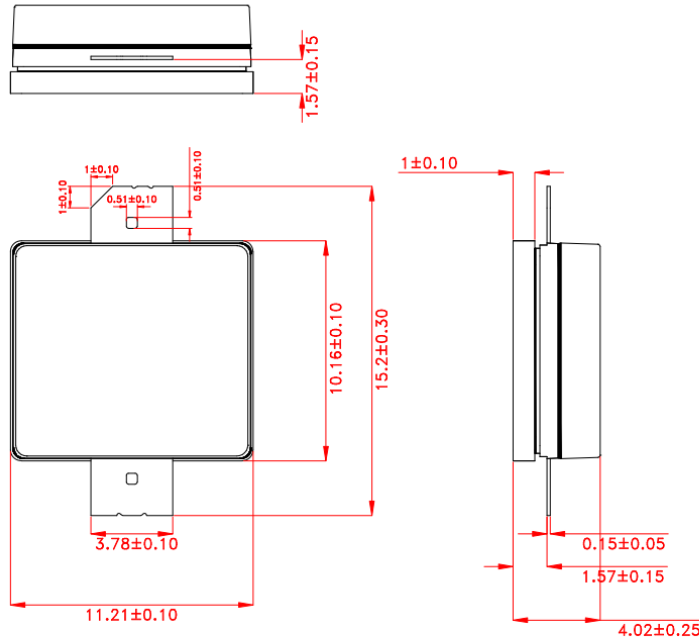


Figure 4. Network analyzer output S11/S21





### Package Dimensions



Unit:mm

Tolerance ±0.10mm,Except as Noted.

### Revision history

Table 7. Document revision history

Date	Revision	Datasheet Status
2024/9/13	Rev 1.0	Preliminary Datasheet

Application data based on ZYX-24-60

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